

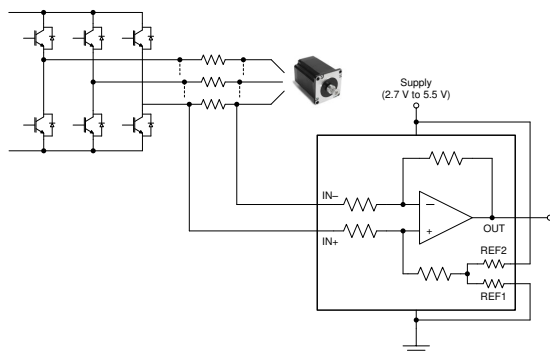
INA240 -4V 至 80V、具有增强型 PWM 抑制的双向、超精密电流检测放大器

1 特性

- 增强型 PWM 抑制
- 出色的共模抑制比 (CMRR) :
 - 132dB DC CMRR
 - 93dB AC CMRR (50kHz 时)
- 宽共模范围：-4V 至 80V
- 精度：
 - 增益：
 - 增益误差：0.20% (最大值)
 - 增益漂移：2.5ppm/°C (最大值)
 - 偏移：
 - 失调电压：±25 μV (最大值)
 - 温漂：250nV/°C (最大值)
- 可用的增益：
 - INA240A1：20V/V
 - INA240A2：50V/V
 - INA240A3：100V/V
 - INA240A4：200V/V
- 静态电流：2.4mA (最大值)

2 应用

- 电机控制
- 螺线管和阀门控制
- 电源管理
- 致动器控制
- 压力调节器
- 电信设备



典型应用

3 说明

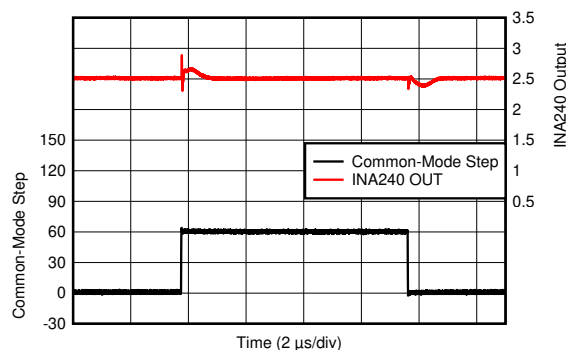
INA240 器件是一款电压输出、电流检测放大器，具有增强型 PWM 抑制功能，可在独立于电源电压的 -4V 至 80V 宽共模电压范围内检测分流器电阻上的压降。负共模电压允许器件的工作电压低于接地电压，从而适应典型螺线管应用的反激周期。增强型 PWM 抑制功能可为使用脉宽调制 (PWM) 信号的系統 (例如，电机驱动和螺线管控制系统) 中的较大共模瞬变 ($\Delta V/\Delta t$) 提供高水平的抑制。凭借该功能，可精确测量电流，而不会使输出电压产生较大的瞬变及相应的恢复纹波。

该器件由 2.7V 至 5.5V 的单电源供电运行，消耗的最大电源电流为 2.4mA。共有四种固定增益可供选择：20V/V、50V/V、100V/V 以及 200V/V。零漂移架构的低偏移使得该器件能够在分流器上的最大压降低至 10mV (满量程) 的情况下进行电流感应。所有版本均具有扩展额定工作温度范围 (-40°C 至 +125°C)，并且采用 8 引脚 TSSOP 和 8 引脚 SOIC 封装。

器件信息⁽¹⁾

器件型号	封装	封装尺寸 (标称值)
INA240	TSSOP (8)	3.00mm × 4.40mm
	SOIC (8)	4.90mm × 3.91mm

(1) 如需了解所有可用封装，请参阅数据表末尾的封装选项附录。



增强型 PWM 抑制

D004



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4 Revision History

注：以前版本的页码可能与当前版本的页码不同

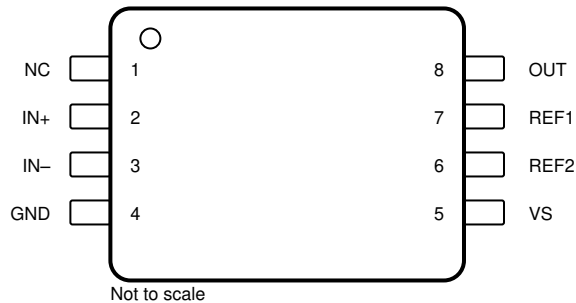
Changes from Revision B (October 2017) to Revision C (December 2021)	Page
• 将 D (SOIC) 封装尺寸从 4.00mm × 3.91mm 更改为 4.90mm × 3.91mm.....	1
• Added text <i>or leave unconnected.</i> to the NC pin description.....	3
Changes from Revision A (October 2016) to Revision B (October 2017)	Page
• 向器件信息表添加了 D (SOIC) 封装.....	1
• 添加了说明 (续) 部分.....	1
• 向 8 引脚 TSSOP 封装添加了预发布标签.....	1
• Added D (SOIC) pinout diagram and table to <i>Pin Configuration and Functions</i> section	3
• Changed y-axis values in 图 7-15	6
• Added 图 11-2	24
Changes from Revision * (July 2016) to Revision A (October 2016)	Page
• 将文档状态从“产品预发布”更改为“量产数据”	1

5 Device Comparison

表 5-1. Device Comparison

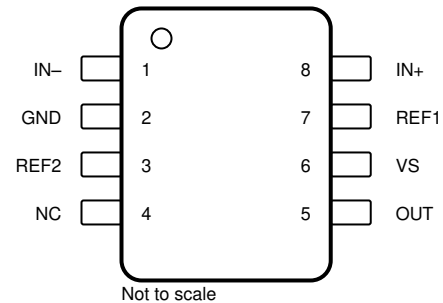
PRODUCT	GAIN (V/V)
INA240A1	20
INA240A2	50
INA240A3	100
INA240A4	200

6 Pin Configuration and Functions



NC- no internal connection

图 6-1. INA240 PW Package 8-Pin TSSOP Top View



NC- no internal connection

图 6-2. INA240 D Package 8-Pin SOIC Top View

表 6-1. Pin Functions

NAME	PIN		I/O	DESCRIPTION
	PW (TSSOP)	D (SOIC)		
GND	4	2	Analog	Ground
IN -	3	1	Analog input	Connect to load side of shunt resistor
IN+	2	8	Analog input	Connect to supply side of shunt resistor
NC	1	4	—	Reserved. Connect to ground or leave floating
OUT	8	5	Analog output	Output voltage
REF1	7	7	Analog input	Reference 1 voltage. Connect to 0 V to VS; see the Adjusting the Output Midpoint With the Reference Pins section for connection options
REF2	6	3	Analog input	Reference 2 voltage. Connect to 0 V to VS; see the Adjusting the Output Midpoint With the Reference Pins section for connection options
VS	5	6	—	Power supply, 2.7 V to 5.5 V

7 Specifications

7.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)⁽¹⁾

		MIN	MAX	UNIT
Supply voltage			6	V
Analog inputs, V_{IN+} , V_{IN-} ⁽²⁾	Differential (V_{IN+}) - (V_{IN-})	- 80	80	V
	Common-mode	- 6	90	
REF1, REF2, NC inputs		GND - 0.3	$V_S + 0.3$	V
Output		GND - 0.3	$V_S + 0.3$	V
Operating free-air temperature, T_A		- 55	150	°C
Junction temperature, T_J			150	°C
Storage temperature, T_{stg}		- 65	150	°C

(1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) V_{IN+} and V_{IN-} are the voltages at the IN+ and IN- pins, respectively.

7.2 ESD Ratings

		VALUE	UNIT
$V_{(ESD)}$ Electrostatic discharge	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾	±2000	V
	Charged-device model (CDM), per JEDEC specification JESD22-C101 ⁽²⁾	±1000	

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

		MIN	NOM	MAX	UNIT
V_{CM}	Common-mode input voltage	- 4		80	V
V_S	Operating supply voltage	2.7		5.5	V
T_A	Operating free-air temperature	- 40		125	°C

7.4 Thermal Information

THERMAL METRIC ⁽¹⁾		INA240		UNIT
		PW (TSSOP)	D (SOIC)	
		8 PINS	8 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	149.1	113.5	°C/W
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	33.2	51.9	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	78.4	57.8	°C/W
ψ_{JT}	Junction-to-top characterization parameter	1.5	10.2	°C/W
ψ_{JB}	Junction-to-board characterization parameter	76.4	56.9	°C/W

(1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

7.5 Electrical Characteristics

at $T_A = 25^\circ\text{C}$, $V_S = 5\text{ V}$, $V_{\text{SENSE}} = V_{\text{IN}+} - V_{\text{IN}-}$, $V_{\text{CM}} = 12\text{ V}$, and $V_{\text{REF1}} = V_{\text{REF2}} = V_S / 2$ (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
INPUT						
V _{CM}	Common-mode input range	V _{IN+} = - 4 V to 80 V, V _{SENSE} = 0 mV T _A = - 40°C to 125°C	- 4		80	V
CMRR	Common-mode rejection ratio	V _{IN+} = - 4 V to 80 V, V _{SENSE} = 0 mV T _A = - 40°C to 125°C	120	132		dB
		f = 50 kHz		93		
V _{OS}	Offset voltage, input-referred	V _{SENSE} = 0 mV		±5	±25	µV
dV _{OS} /dT	Offset voltage drift	V _{SENSE} = 0 mV, T _A = - 40°C to 125°C		±50	±250	nV/°C
PSRR	Power-supply rejection ratio	V _S = 2.7 V to 5.5 V, V _{SENSE} = 0 mV T _A = - 40°C to 125°C		±1	±10	µV/V
I _B	Input bias current	I _{B+} , I _{B-} , V _{SENSE} = 0 mV		90		µA
	Reference input range		0		V _S	V
OUTPUT						
G	Gain	INA240A1		20		V/V
		INA240A2		50		
		INA240A3		100		
		INA240A4		200		
	Gain error	GND + 50 mV ≤ V _{OUT} ≤ V _S - 200 mV T _A = - 40°C to 125°C		±0.05%	±0.20%	ppm/°C
	Non-linearity error	GND + 10 mV ≤ V _{OUT} ≤ V _S - 200 mV		±0.01%		
	Reference divider accuracy	V _{OUT} = (V _{REF1} - V _{REF2}) / 2 at V _{SENSE} = 0 mV, T _A = - 40°C to 125°C		0.02%	0.1%	
RVRR	Reference voltage rejection ratio (input-referred)	INA240A1		20		µV/V
		INA240A3		5		
		INA240A2, INA240A4		2		
	Maximum capacitive load	No sustained oscillation		1		nF
VOLTAGE OUTPUT ⁽²⁾						
	Swing to V _S power-supply rail	R _L = 10 k Ω to GND T _A = - 40°C to 125°C		V _S - 0.05	V _S - 0.2	V
	Swing to GND	R _L = 10 k Ω to GND, V _{SENSE} = 0 mV V _{REF1} = V _{REF2} = 0 V, T _A = - 40°C to 125°C		V _{GND} + 1	V _{GND} + 10	mV
FREQUENCY RESPONSE						
BW	Bandwidth	All gains, - 3-dB bandwidth		400		kHz
		All gains, 2% THD+N ⁽¹⁾		100		
	Settling time - output settles to 0.5% of final value	INA240A1		9.6		µs
		INA240A4		9.8		
SR	Slew rate			2		V/µs
NOISE (INPUT REFERRED)						
	Voltage noise density			40		nV/ √ Hz
POWER SUPPLY						
V _S	Operating voltage range	T _A = - 40°C to 125°C	2.7		5.5	V
I _Q	Quiescent current	V _{SENSE} = 0 mV		1.8	2.4	mA
		I _Q vs temperature, T _A = - 40°C to 125°C			2.6	
TEMPERATURE RANGE						
	Specified range		- 40		125	°C

(1) See the [Input Signal Bandwidth](#) section for more details.

(2) See [Figure 7-13](#).

7.6 Typical Characteristics

at $T_A = 25^\circ\text{C}$, $V_S = 5\text{ V}$, $V_{CM} = 12\text{ V}$, and $V_{REF} = V_S / 2$ (unless otherwise noted)

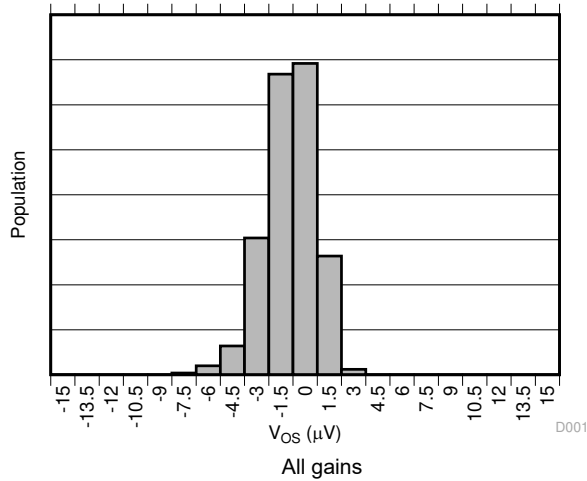


图 7-1. Input Offset Voltage Production Distribution

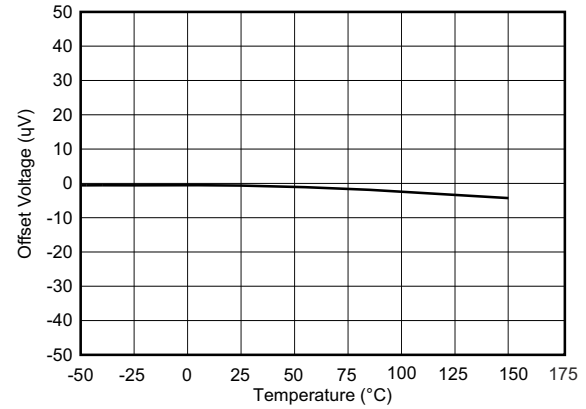


图 7-2. Offset Voltage vs Temperature

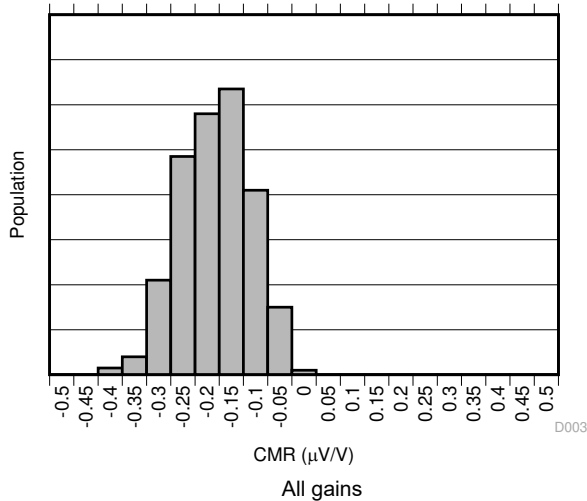


图 7-3. Common-Mode Rejection Production Distribution

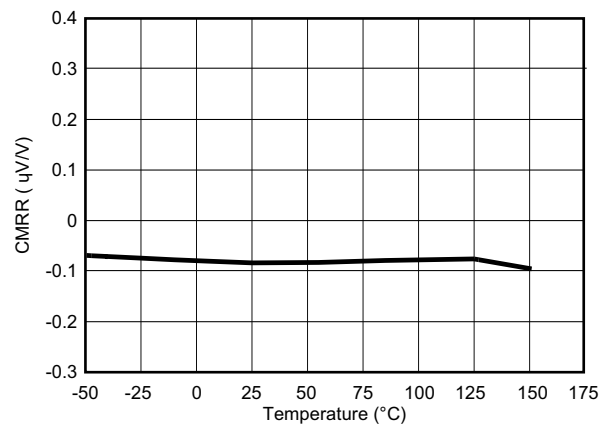


图 7-4. Common-Mode Rejection Ratio vs Temperature

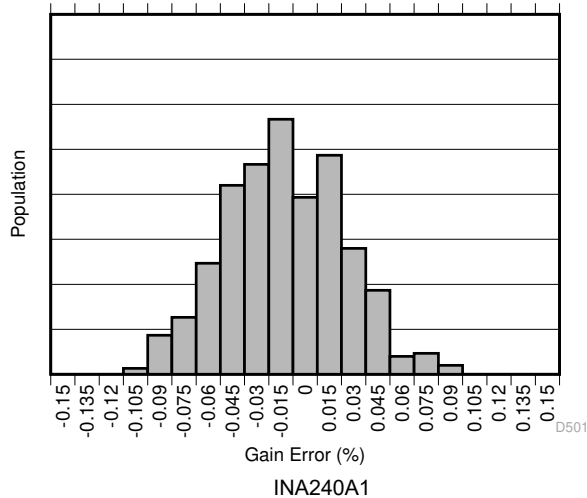


图 7-5. Gain Error Production Distribution

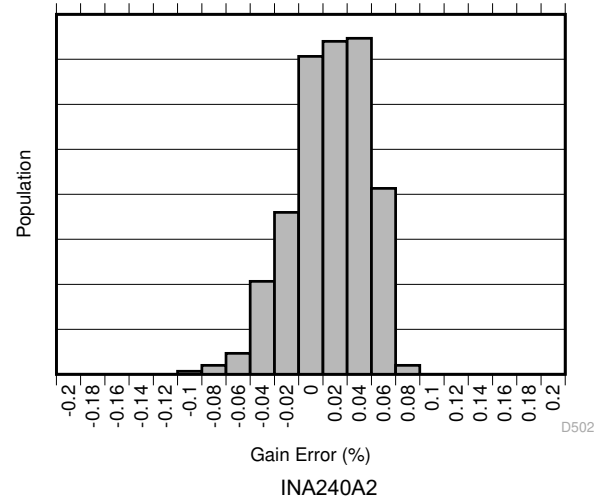


图 7-6. Gain Error Production Distribution

7.6 Typical Characteristics (continued)

at $T_A = 25^\circ\text{C}$, $V_S = 5\text{ V}$, $V_{CM} = 12\text{ V}$, and $V_{REF} = V_S / 2$ (unless otherwise noted)

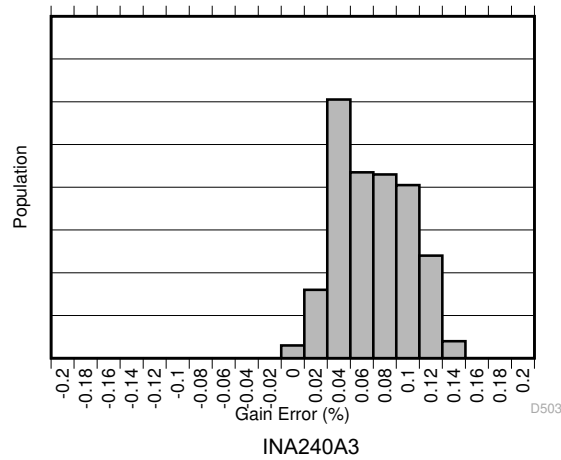


图 7-7. Gain Error Production Distribution

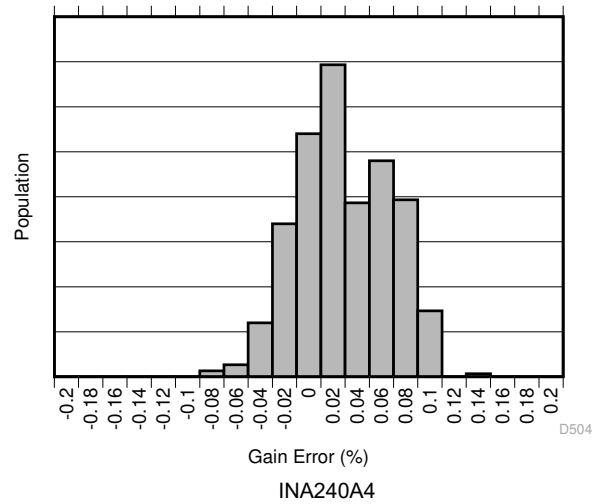


图 7-8. Gain Error Production Distribution

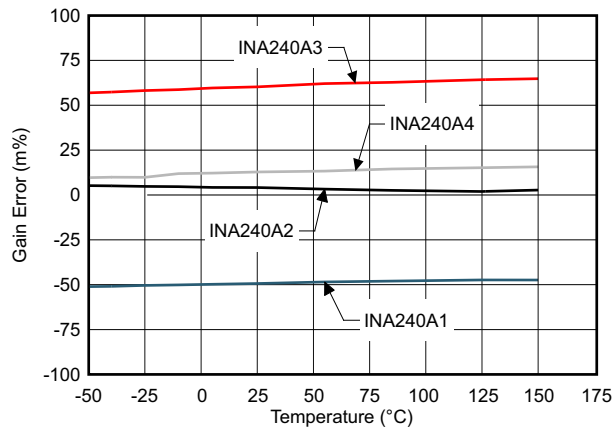


图 7-9. Gain Error vs Temperature

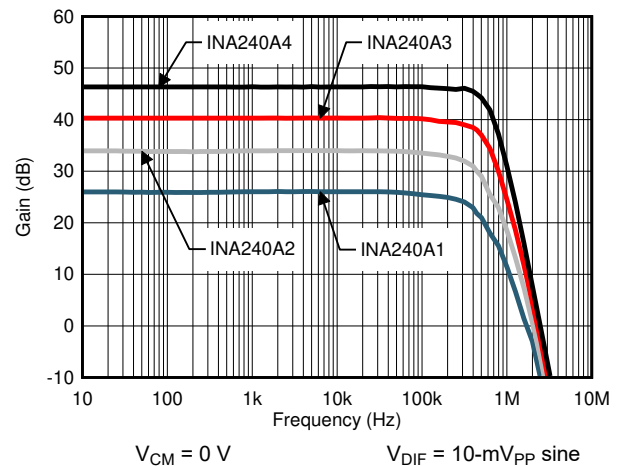


图 7-10. Gain vs Frequency

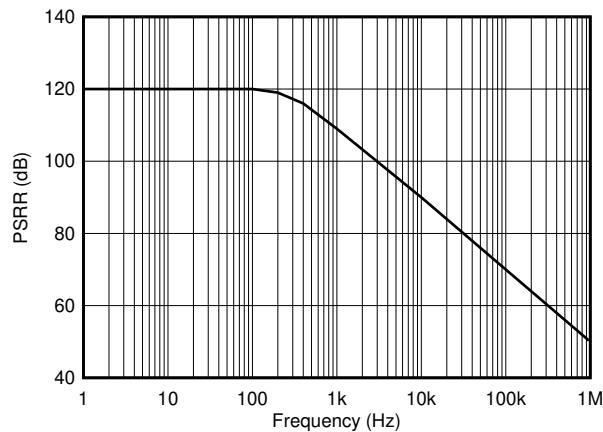


图 7-11. Power-Supply Rejection Ratio vs Frequency

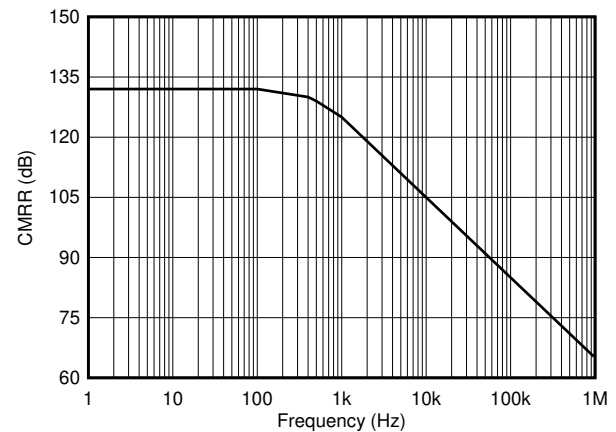


图 7-12. Common-Mode Rejection Ratio vs Frequency

7.6 Typical Characteristics (continued)

at $T_A = 25^\circ\text{C}$, $V_S = 5\text{ V}$, $V_{CM} = 12\text{ V}$, and $V_{REF} = V_S / 2$ (unless otherwise noted)

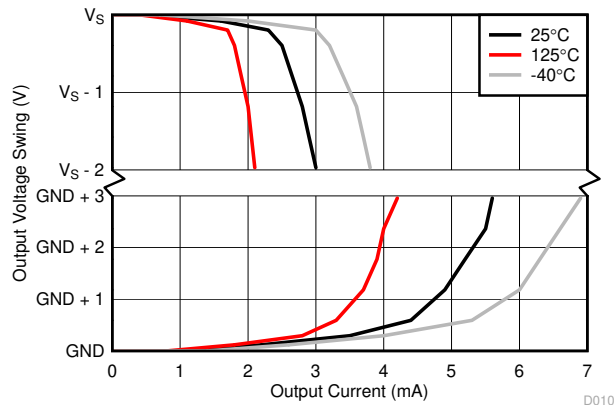


图 7-13. Output Voltage Swing vs Output Current

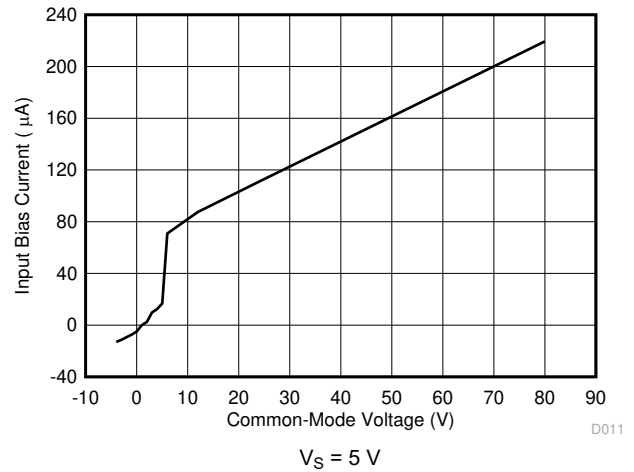


图 7-14. Input Bias Current vs Common-Mode Voltage

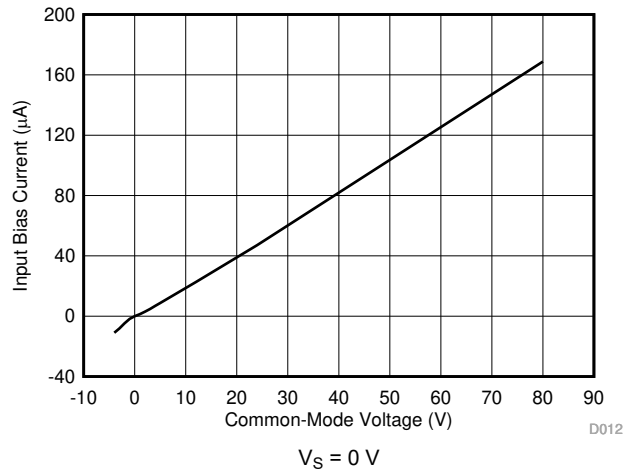


图 7-15. Input Bias Current vs Common-Mode Voltage

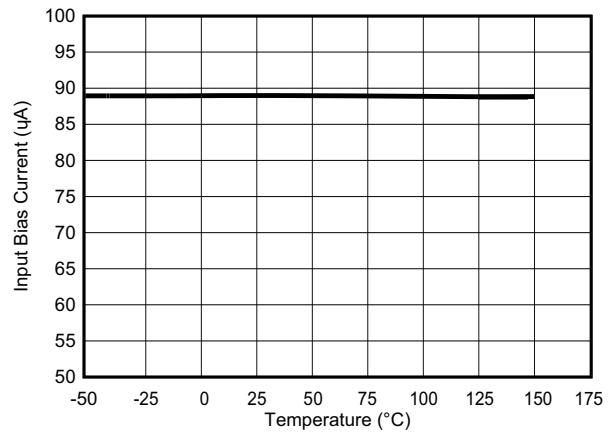


图 7-16. Input Bias Current vs Temperature

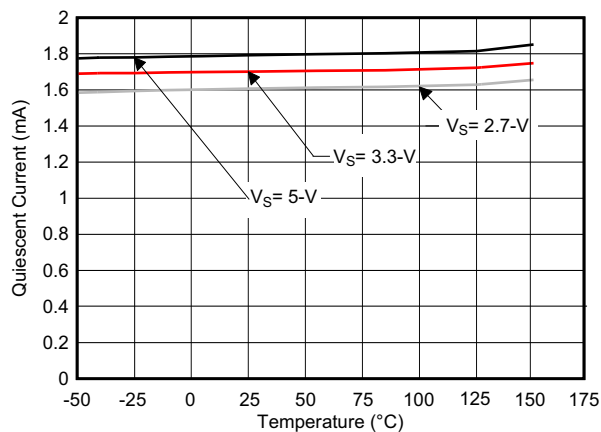


图 7-17. Quiescent Current vs Temperature

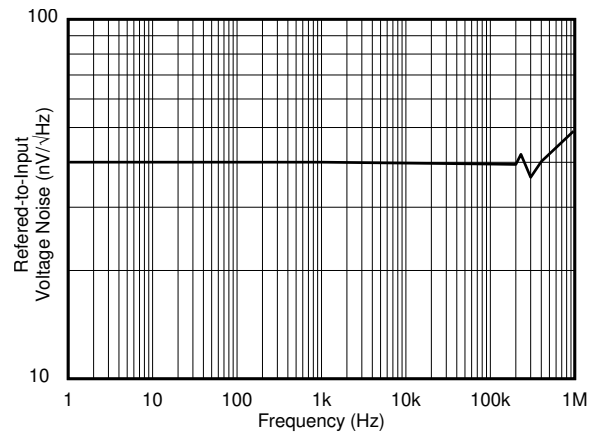
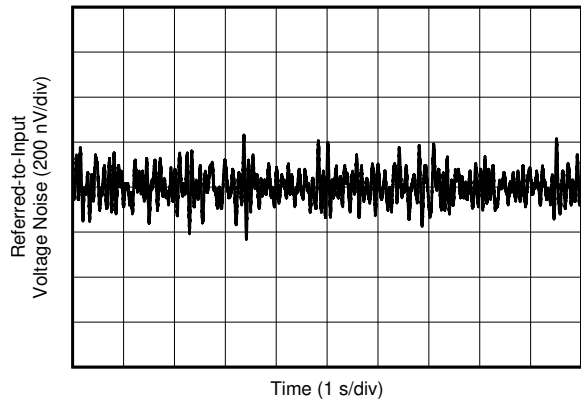


图 7-18. Input-Referred Voltage Noise vs Frequency

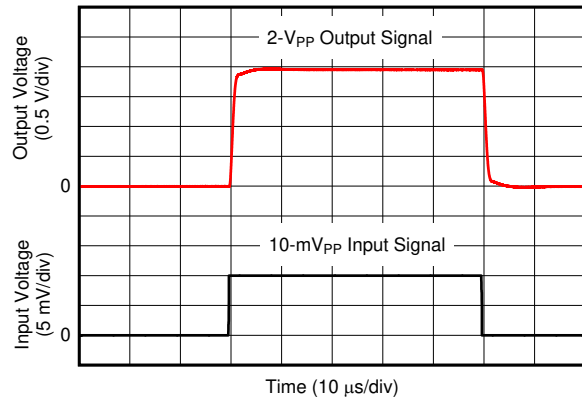
7.6 Typical Characteristics (continued)

at $T_A = 25^\circ\text{C}$, $V_S = 5\text{ V}$, $V_{CM} = 12\text{ V}$, and $V_{REF} = V_S / 2$ (unless otherwise noted)



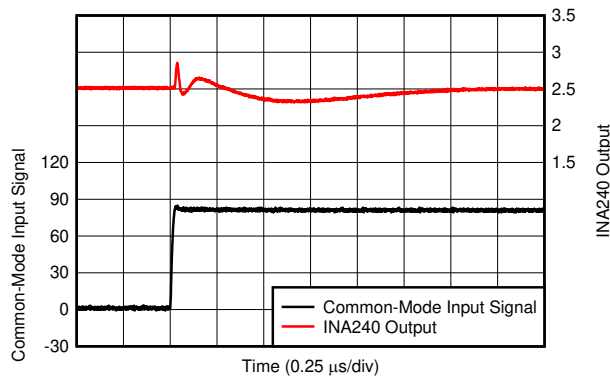
$V_S = \pm 2.5\text{ V}$ $V_{CM} = 0\text{ V}$ $V_{DIF} = 0\text{ V}$
 $V_{REF1} = V_{REF2} = 0\text{ V}$ Input referred

图 7-19. 0.1-Hz to 10-Hz Voltage Noise



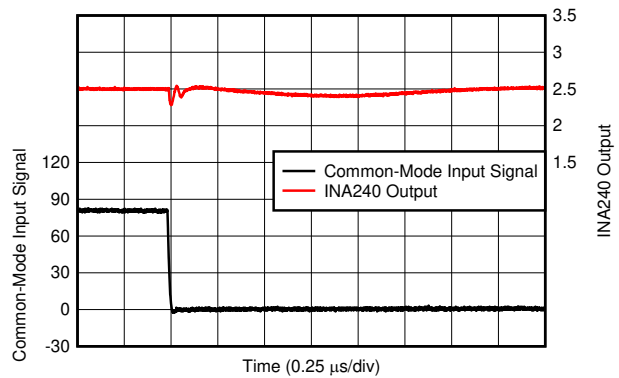
$V_{REF1} = V_{REF2} = 0\text{ V}$ 10-mVpp input step

图 7-20. Step Response



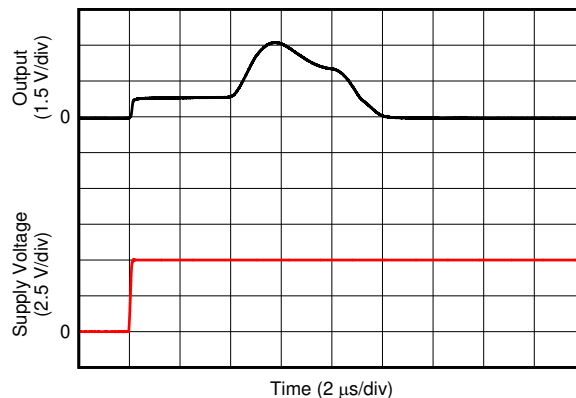
Rising edge

图 7-21. Common-Mode Voltage Transient Response



Falling edge

图 7-22. Common-Mode Voltage Transient Response



$V_{REF1} = V_{REF2} = 0\text{ V}$

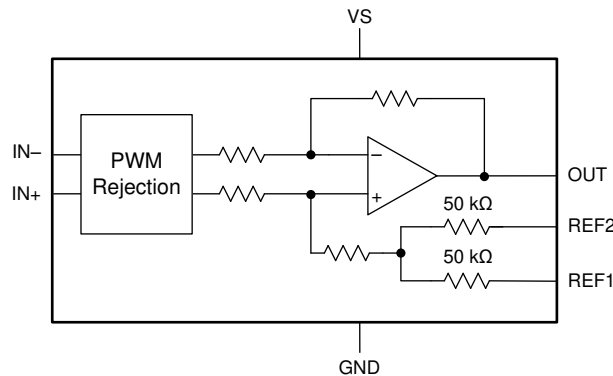
图 7-23. Start-Up Response

8 Detailed Description

8.1 Overview

The INA240 is a current-sense amplifier that offers a wide common-mode range, precision, zero-drift topology, excellent common-mode rejection ratio (CMRR), and features enhanced pulse width modulation (PWM) rejection. Enhanced PWM rejection reduces the effect of common-mode transients on the output signal that are associated with PWM signals. Multiple gain versions are available to allow for the optimization of the desired full-scale output voltage based on the target current range expected in the application.

8.2 Functional Block Diagram



8.3 Feature Description

8.3.1 Amplifier Input Signal

The INA240 is designed to handle large common-mode transients over a wide voltage range. Input signals from current measurement applications for linear and PWM applications can be connected to the amplifier to provide a highly accurate output, with minimal common-mode transient artifacts.

8.3.1.1 Enhanced PWM Rejection Operation

The enhanced PWM rejection feature of the INA240 provides increased attenuation of large common-mode $\Delta V / \Delta t$ transients. Large $\Delta V / \Delta t$ common-mode transients associated with PWM signals are employed in applications such as motor or solenoid drive and switching power supplies. Traditionally, large $\Delta V / \Delta t$ common-mode transitions are handled strictly by increasing the amplifier signal bandwidth, which can increase chip size, complexity and ultimately cost. The INA240 is designed with high common-mode rejection techniques to reduce large $\Delta V / \Delta t$ transients before the system is disturbed as a result of these large signals. The high AC CMRR, in conjunction with signal bandwidth, allows the INA240 to provide minimal output transients and ringing compared with standard circuit approaches.

8.3.1.2 Input Signal Bandwidth

The INA240 input signal, which represents the current being measured, is accurately measured with minimal disturbance from large $\Delta V / \Delta t$ common-mode transients as previously described. For PWM signals typically associated with motors, solenoids, and other switching applications, the current being monitored varies at a significantly slower rate than the faster PWM frequency.

The INA240 bandwidth is defined by the -3 -dB bandwidth of the current-sense amplifier inside the device; see the [Electrical Characteristics](#) table. The device bandwidth provides fast throughput and fast response required for the rapid detection and processing of overcurrent events. Without the higher bandwidth, protection circuitry may not have adequate response time and damage may occur to the monitored application or circuit.

图 8-1 shows the performance profile of the device over frequency. Harmonic distortion increases at the upper end of the amplifier bandwidth with no adverse change in detection of overcurrent events. However, increased distortion at the highest frequencies must be considered when the measured current bandwidth begins to approach the INA240 bandwidth.

For applications requiring distortion sensitive signals, 图 8-1 provides information to show that there is an optimal frequency performance range for the amplifier. The full amplifier bandwidth is always available for fast overcurrent events at the same time that the lower frequency signals are amplified at a low distortion level. The output signal accuracy is reduced for frequencies closer to the maximum bandwidth. Individual requirements determine the acceptable limits of distortion for high-frequency, current-sensing applications. Testing and evaluation in the end application or circuit is required to determine the acceptance criteria and to validate the performance levels meet the system specifications.

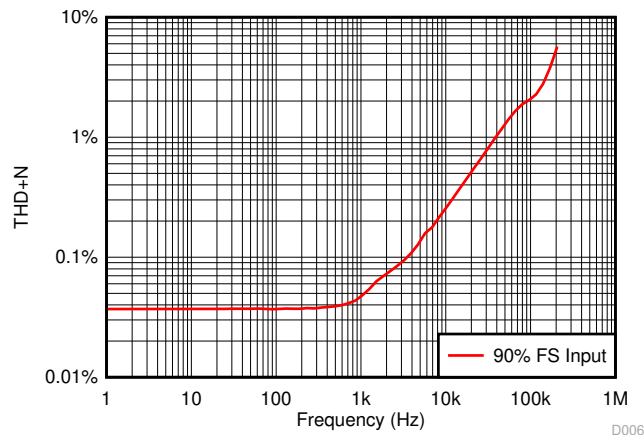


图 8-1. Performance Over Frequency

8.3.2 Selecting the Sense Resistor (R_{SENSE})

The INA240 determines the current magnitude from measuring the differential voltage developed across a resistor. This resistor is referred to as a *current-sensing* resistor or a *current-shunt* resistor. The flexible design of the device allows a wide input signal range across this current-sensing resistor.

The current-sensing resistor is ideally chosen solely based on the full-scale current to be measured, the full-scale input range of the circuitry following the device, and the device gain selected. The minimum current-sensing resistor is a design-based decision in order to maximize the input range of the signal chain circuitry. Full-scale output signals that are not maximized to the full input range of the system circuitry limit the ability of the system to exercise the full dynamic range of system control.

Two important factors to consider when finalizing the current-sensing resistor value are: the required current measurement accuracy and the maximum power dissipation across the resistor. A larger resistor voltage provides for a more accurate measurement, but increases the power dissipation in the resistor. The increased power dissipation generates heat, which reduces the sense resistor accuracy because of the temperature coefficient. The voltage signal measurement uncertainty is reduced when the input signal gets larger because any fixed errors become a smaller percentage of the measured signal. The design trade-off to improve measurement accuracy increases the current-sensing resistor value. The increased resistance value results in an increased power dissipation in the system which can additionally decrease the overall system accuracy. Based on these relationships, the measurement accuracy is inversely proportional to both the resistance value and power dissipation contributed by the current-shunt selection.

By increasing the current-shunt resistor, the differential voltage is increased across the resistor. Larger input differential voltages require a smaller amplifier gain to achieve a full-scale amplifier output voltage. Smaller current-shunt resistors are desired but require large amplifier gain settings. The larger gain settings often have increased error and noise parameters, which are not attractive for precision designs. Historically, the design goals for high-performance measurements forced designers to accept selecting larger current-sense resistors and the lower gain amplifier settings. The INA240 provides 100-V/V and 200-V/V gain options that offer the high-

gain setting and maintains high-performance levels with offset values below 25 μV . These devices allow for the use of lower shunt resistor values to achieve lower power dissipation and still meet high system performance specifications.

表 8-1 shows an example of the different results obtained from using two different gain versions of the INA240. From the table data, the higher gain device allows a smaller current-shunt resistor and decreased power dissipation in the element. The [Calculating Total Error](#) section provides information on the error calculations that must be considered in addition to the gain and current-shunt value when designing with the INA240.

表 8-1. R_{SENSE} Selection and Power Dissipation⁽¹⁾

PARAMETER	EQUATION	RESULTS	
		INA240A1	INA240A4
Gain	—	20 V/V	200 V/V
V_{DIFF} Ideal maximum differential input voltage	$V_{\text{DIFF}} = V_{\text{OUT}} / \text{Gain}$	150 mV	15 mV
R_{SENSE} Current-sense resistor value	$R_{\text{SENSE}} = V_{\text{DIFF}} / I_{\text{MAX}}$	15 m Ω	1.5 m Ω
P_{RSENSE} Current-sense resistor power dissipation	$R_{\text{SENSE}} \times I_{\text{MAX}}^2$	1.5 W	0.15 W

(1) Full-scale current = 10 A, and full-scale output voltage = 3 V.

8.4 Device Functional Modes

8.4.1 Adjusting the Output Midpoint With the Reference Pins

图 8-2 shows a test circuit for reference-divider accuracy. The INA240 output is configurable to allow for unidirectional or bidirectional operation.

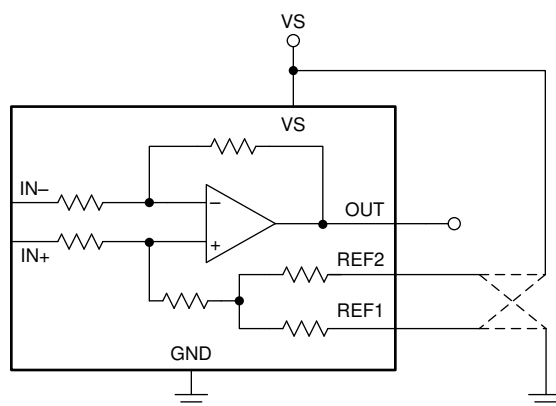


图 8-2. Test Circuit For Reference Divider Accuracy

备注

Do not connect the REF1 pin or the REF2 pin to any voltage source lower than GND or higher than V_S .

The output voltage is set by applying a voltage or voltages to the reference voltage inputs, REF1 and REF2. The reference inputs are connected to an internal gain network. There is no operational difference between the two reference pins.

8.4.2 Reference Pin Connections for Unidirectional Current Measurements

Unidirectional operation allows current measurements through a resistive shunt in one direction. For unidirectional operation, connect the device reference pins together and then to the negative rail (see the [Ground Referenced Output](#) section) or the positive rail (see the [VS Referenced Output](#) section). The required differential input polarity depends on the output voltage setting. The amplifier output moves away from the referenced rail proportional to the current passing through the external shunt resistor. If the amplifier reference pins are connected to the positive rail, then the input polarity must be negative to move the amplifier output down

(towards ground). If the amplifier reference pins are connected at ground, then the input polarity must be positive to move the amplifier output up (towards supply).

The following sections describe how to configure the output for unidirectional operation cases.

8.4.2.1 Ground Referenced Output

When using the INA240 in a unidirectional mode with a ground referenced output, both reference inputs are connected to ground; this configuration takes the output to ground when there is a 0-V differential at the input (as 图 8-3 shows).

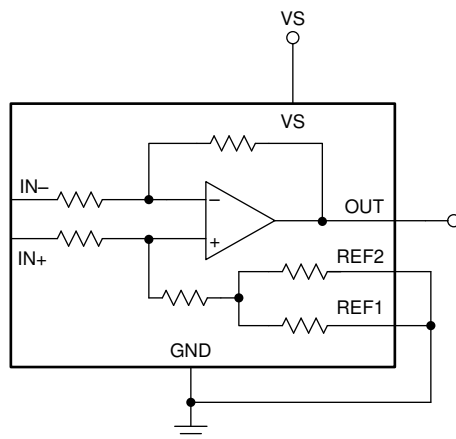


图 8-3. Ground Referenced Output

8.4.2.2 VS Referenced Output

Unidirectional mode with a VS referenced output is configured by connecting both reference pins to the positive supply. Use this configuration for circuits that require power-up and stabilization of the amplifier output signal and other control circuitry before power is applied to the load (as shown in 图 8-4).

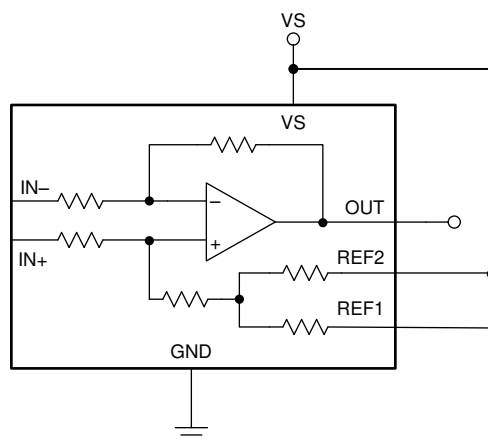


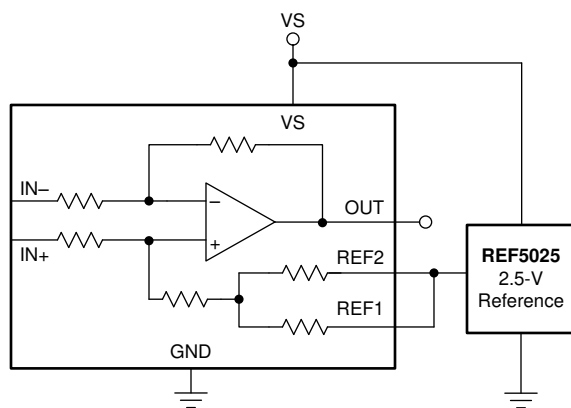
图 8-4. VS Referenced Output

8.4.3 Reference Pin Connections for Bidirectional Current Measurements

Bidirectional operation allows the INA240 to measure currents through a resistive shunt in two directions. For this operation case, the output voltage can be set anywhere within the reference input limits. A common configuration is to set the reference inputs at half-scale for equal range in both directions. However, the reference inputs can be set to a voltage other than half-scale when the bidirectional current is non-symmetrical.

8.4.3.1 Output Set to External Reference Voltage

Connecting both pins together and then to a reference voltage results in an output voltage equal to the reference voltage for the condition of shorted input pins or a 0-V differential input; this configuration is shown in 图 8-5. The output voltage decreases below the reference voltage when the IN+ pin is negative relative to the IN - pin and increases when the IN+ pin is positive relative to the IN - pin. This technique is the most accurate way to bias the output to a precise voltage.



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图 8-5. External Reference Output

8.4.3.2 Output Set to Midsupply Voltage

By connecting one reference pin to VS and the other to the GND pin, the output is set at half of the supply when there is no differential input, as shown in 图 8-6. This method creates a ratiometric offset to the supply voltage, where the output voltage remains at $VS / 2$ for 0 V applied to the inputs.

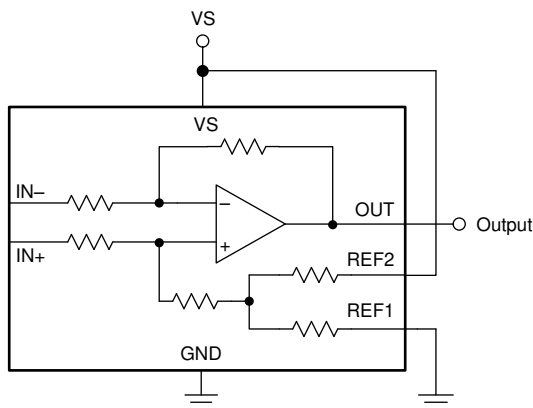
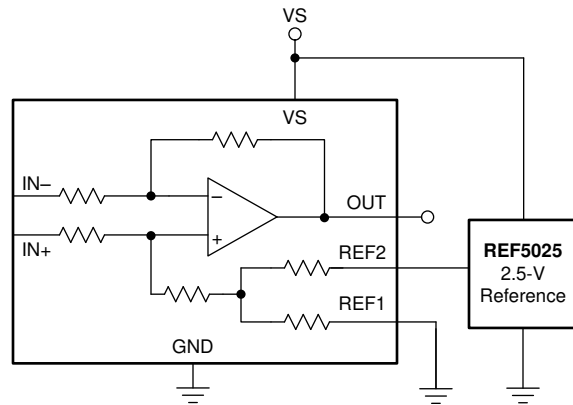


图 8-6. Midsupply Voltage Output

8.4.3.3 Output Set to Mid-External Reference

In this case, an external reference is divided by two by connecting one REF pin to ground and the other REF pin to the reference, as shown in 图 8-7.



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图 8-7. Mid-External Reference Output

8.4.3.4 Output Set Using Resistor Divider

The INA240 REF1 and REF2 pins allow for the midpoint of the output voltage to be adjusted for system circuitry connections to analog to digital converters (ADCs) or other amplifiers. The REF pins are designed to be connected directly to supply, ground, or a low-impedance reference voltage. The REF pins can be connected together and biased using a resistor divider to achieve a custom output voltage. If the amplifier is used in this configuration, as shown in 图 8-8, use the output as a differential signal with respect to the resistor divider voltage. Use of the amplifier output as a single-ended signal in this configuration is not recommended because the internal impedance shifts can adversely affect device performance specifications.

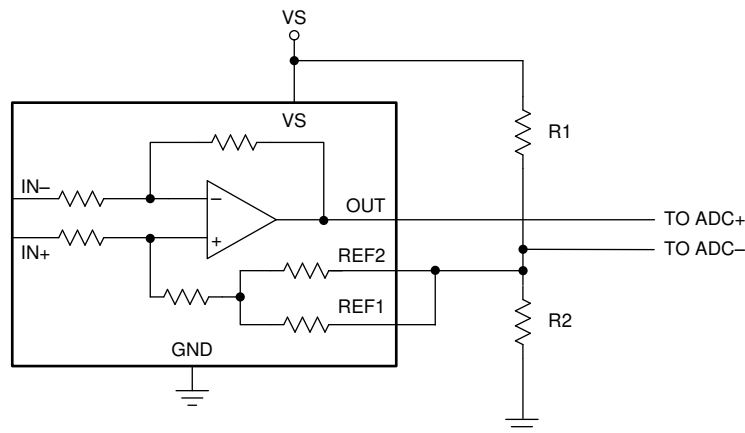


图 8-8. Setting the Reference Using a Resistor Divider

8.4.4 Calculating Total Error

The INA240 electrical specifications (see the [Electrical Characteristics](#) table) include typical individual errors terms (such as gain error, offset error, and nonlinearity error). Total error, including all of these individual error components, is not specified in the [Electrical Characteristics](#) table. In order to accurately calculate the expected error of the device, the device operating conditions must first be known. Some current-shunt monitors specify a total error in the product data sheet. However, this total error term is accurate under only one particular set of operating conditions. Specifying the total error at this point has limited value because any deviation from these specific operating conditions no longer yields the same total error value. This section discusses the individual error sources and how the device total error value can be calculated from the combination of these errors for specific conditions.

Two examples are provided in 表 8-2 and 表 8-3 that detail how different operating conditions can affect the total error calculations. Typical and maximum calculations are shown as well to provide the user more information on how much error variance is present from device to device.

8.4.4.1 Error Sources

The typical error sources that have the largest effect on the total error of the device are gain error, nonlinearity, common-mode rejection ratio, and input offset voltage error. For the INA240, an additional error source (referred to as the *reference voltage rejection ratio*) is also included in the total error value.

8.4.4.2 Reference Voltage Rejection Ratio Error

Reference voltage rejection ratio refers to the amount of error induced by applying a reference voltage to the INA240 that deviates from the mid-point of the device supply voltage.

8.4.4.2.1 Total Error Example 1

表 8-2. Total Error Calculation: Example 1⁽¹⁾

TERM	SYMBOL	EQUATION	TYPICAL VALUE
Initial input offset voltage	V_{OS}	—	5 μ V
Added input offset voltage because of common-mode voltage	V_{OS_CM}	$\frac{1}{10^{\left(\frac{CMRR_{dB}}{20}\right)}} \times (V_{CM} - 12V)$	0 μ V
Added input offset voltage because of reference voltage	V_{OS_REF}	$RVRR \times V_S / 2 - V_{REF} $	0 μ V
Total input offset voltage	V_{OS_Total}	$\sqrt{(V_{OS})^2 + (V_{OS_CM})^2 + (V_{OS_REF})^2}$	5 μ V
Error from input offset voltage	Error_ V_{OS}	$\frac{V_{OS_Total}}{V_{SENSE}} \times 100$	0.05%
Gain error	Error_Gain	—	0.05%
Nonlinearity error	Error_Lin	—	0.01%
Total error	—	$\sqrt{(\text{Error_}V_{OS})^2 + (\text{Error_Gain})^2 + (\text{Error_Lin})^2}$	0.07%

(1) The data for 表 8-2 was taken with the INA240A4, $V_S = 5$ V, $V_{CM} = 12$ V, $V_{REF1} = V_{REF2} = V_S / 2$, and $V_{SENSE} = 10$ mV.

8.4.4.2.2 Total Error Example 2

表 8-3. Total Error Calculation: Example 2⁽¹⁾

TERM	SYMBOL	EQUATION	TYPICAL VALUE
Initial input offset voltage	V_{OS}	—	5 μ V
Added input offset voltage because of common-mode voltage	V_{OS_CM}	$\frac{1}{10^{\left(\frac{CMRR_{dB}}{20}\right)}} \times (V_{CM} - 12V)$	12.1 μ V
Added input offset voltage because of reference voltage	V_{OS_REF}	$RVRR \times V_S / 2 - V_{REF} $	5 μ V
Total input offset voltage	V_{OS_Total}	$\sqrt{(V_{OS})^2 + (V_{OS_CM})^2 + (V_{OS_REF})^2}$	14 μ V
Error from input offset voltage	Error_ V_{OS}	$\frac{V_{OS_Total}}{V_{SENSE}} \times 100$	0.14%
Gain error	Error_Gain	—	0.05%
Nonlinearity error	Error_Lin	—	0.01%

表 8-3. Total Error Calculation: Example 2⁽¹⁾ (continued)

TERM	SYMBOL	EQUATION	TYPICAL VALUE
Total error	—	$\sqrt{(\text{Error_V}_{\text{OS}})^2 + (\text{Error_Gain})^2 + (\text{Error_Lin})^2}$	0.15%

(1) The data for 表 8-3 was taken with the INA240A4, $V_S = 5\text{ V}$, $V_{\text{CM}} = 60\text{ V}$, $V_{\text{REF1}} = V_{\text{REF2}} = 0\text{ V}$, and $V_{\text{SENSE}} = 10\text{ mV}$.

9 Application and Implementation

备注

以下应用部分中的信息不属于 TI 器件规格的范围，TI 不担保其准确性和完整性。TI 的客户应负责确定器件是否适用于其应用。客户应验证并测试其设计，以确保系统功能。

9.1 Application Information

The INA240 measures the voltage developed as current flows across the current-sensing resistor. The device provides reference pins to configure operation as either unidirectional or bidirectional output swing. When using the INA240 for inline motor current sense, the device is commonly configured for bidirectional operation.

9.1.1 Input Filtering

备注

Input filters are not required for accurate measurements using the INA240, and use of filters in this location is not recommended. If filter components are used on the input of the amplifier, follow the guidelines in this section to minimize the effects on performance.

Based strictly on user design requirements, external filtering of the current signal may be desired. The initial location that can be considered for the filter is at the output of the current amplifier. Although placing the filter at the output satisfies the filtering requirements, this location changes the low output impedance measured by any circuitry connected to the output voltage pin. The other location for filter placement is at the current amplifier input pins. This location satisfies the filtering requirement also, however the components must be carefully selected to minimally impact device performance. 图 9-1 shows a filter placed at the inputs pins.

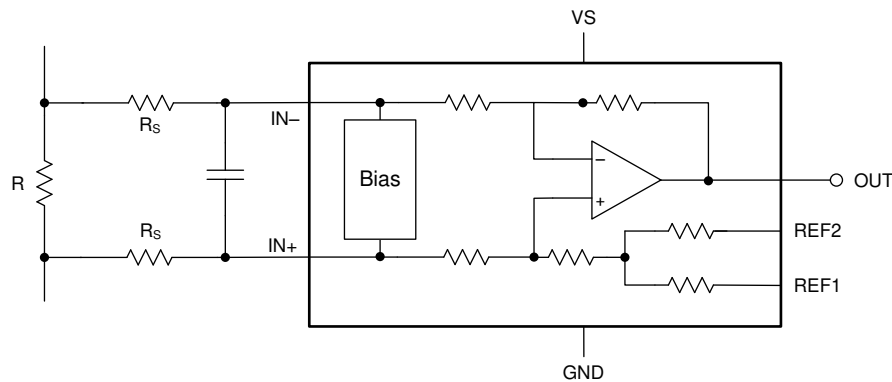


图 9-1. Filter at Input Pins

External series resistance provide a source of additional measurement error, so keep the value of these series resistors to 10- Ω or less to reduce loss of accuracy. The internal bias network shown in 图 9-1 creates a mismatch in input bias currents (see 图 9-2) when a differential voltage is applied between the input pins. If additional external series filter resistors are added to the circuit, a mismatch is created in the voltage drop across the filter resistors. This voltage is a differential error voltage in the shunt resistor voltage. In addition to the absolute resistor value, mismatch resulting from resistor tolerance can significantly impact the error because this value is calculated based on the actual measured resistance.

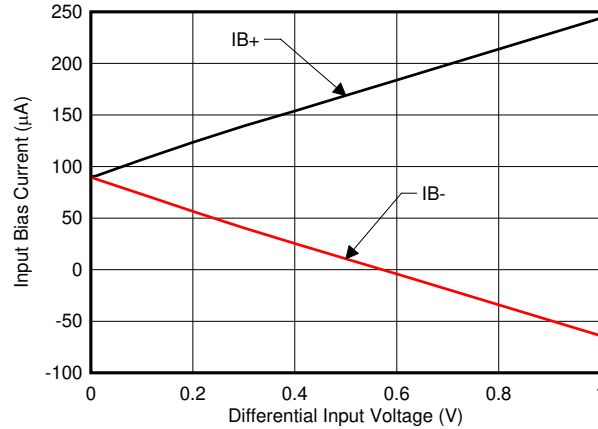


图 9-2. Input Bias Current vs Differential Input Voltage

The measurement error expected from the additional external filter resistors can be calculated using 方程式 1, where the gain error factor is calculated using 方程式 2.

$$\text{Gain Error (\%)} = 100 - (100 \times \text{Gain Error Factor}) \quad (1)$$

The gain error factor, shown in 方程式 1, can be calculated to determine the gain error introduced by the additional external series resistance. 方程式 1 calculates the deviation of the shunt voltage resulting from the attenuation and imbalance created by the added external filter resistance. 表 9-1 provides the gain error factor and gain error for several resistor values.

$$\text{Gain Error Factor} = \frac{3000}{R_S + 3000} \quad (2)$$

Where:

- R_S is the external filter resistance value

表 9-1. Gain Error Factor and Gain Error For External Input Resistors

EXTERNAL RESISTANCE (Ω)	GAIN ERROR FACTOR	GAIN ERROR (%)
5	0.998	0.17
10	0.997	0.33
100	0.968	3.23

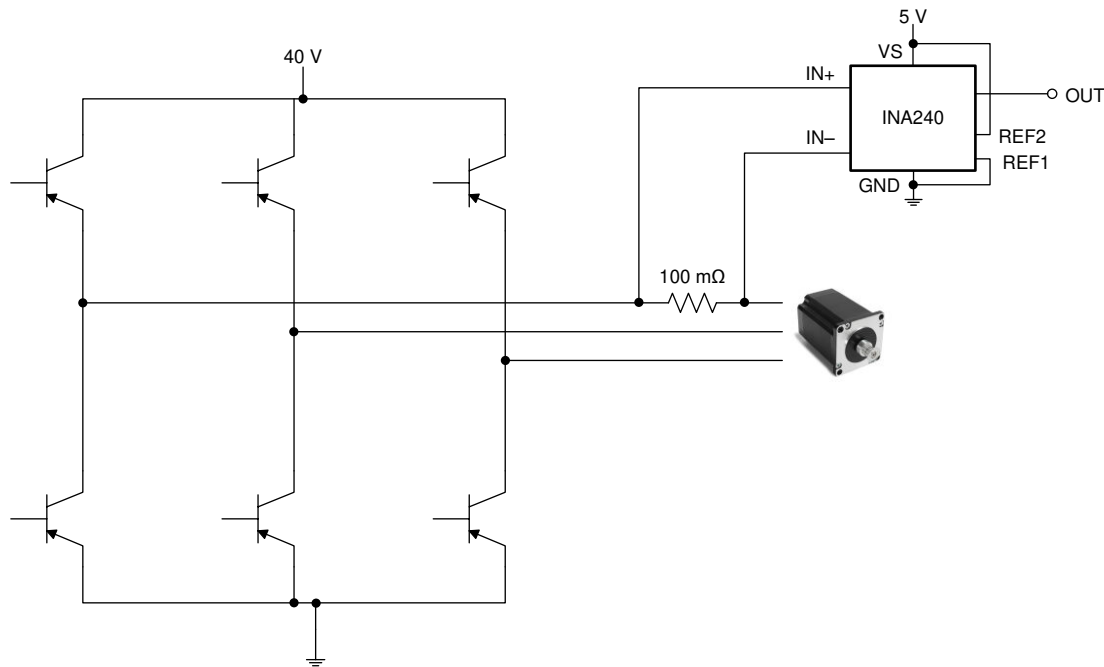
9.2 Typical Applications

The INA240 offers advantages for multiple applications including the following:

- High common-mode range and excellent CMRR enables direct inline sensing
- Ultra-low offset and drift eliminates the necessity of calibration
- Wide supply range enables a direct interface with most microprocessors

Two specific applications are provided and include more detailed information.

9.2.1 Inline Motor Current-Sense Application



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图 9-3. Inline Motor Application Circuit

9.2.1.1 Design Requirements

Inline current sensing has many advantages in motor control, from torque ripple reduction to real-time motor health monitoring. However, the full-scale PWM voltage requirements for inline current measurements provide challenges to accurately measure the current. Switching frequencies in the 50-kHz to 100-kHz range create higher $\Delta V / \Delta t$ signal transitions that must be addressed to obtain accurate inline current measurements.

With a superior common-mode rejection capability, high precision, and a high common-mode specification, the INA240 provides performance for a wide range of common-mode voltages.

9.2.1.2 Detailed Design Procedure

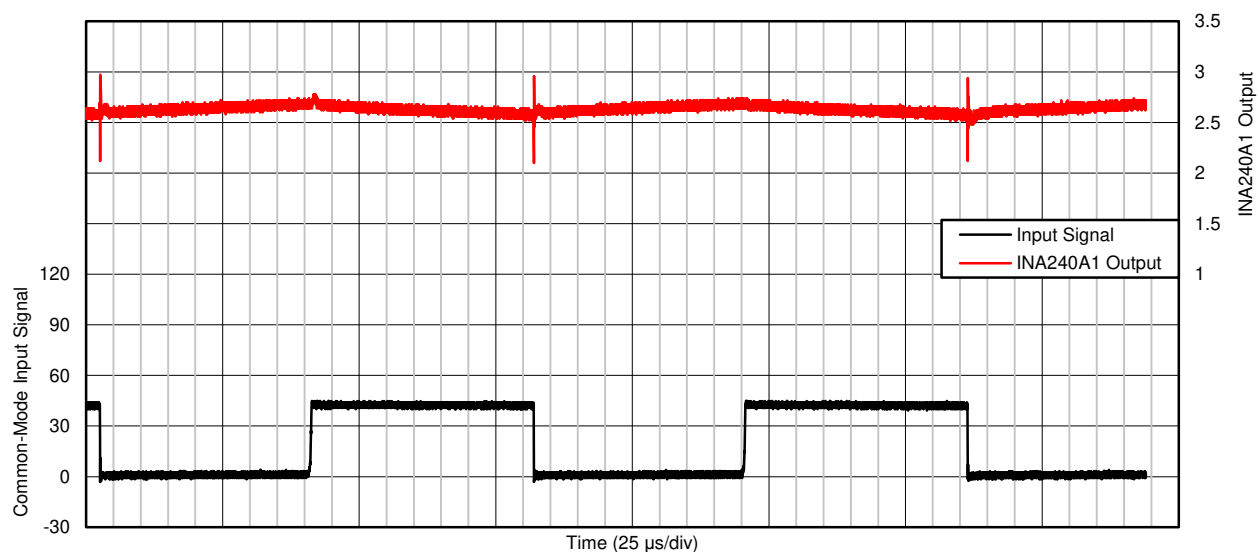
For this application, the INA240 measures current in the drive circuitry of a 36-V, 4000-RPM motor.

To demonstrate the performance of the device, the INA240A1 with a gain of 20 V/V was selected for this design and powered from a 5-V supply.

Using the information in the [Adjusting the Output Midpoint With the Reference Pins](#) section, the reference point is set to midscale by splitting the supply with REF1 connected to ground and REF2 connected to supply. This configuration allows for bipolar current measurements. Alternatively, the reference pins can be tied together and driven with an external precision reference.

The current-sensing resistor is sized so that the output of the INA240 is not saturated. A value of 100-m Ω was selected to maintain the analog input within the device limits.

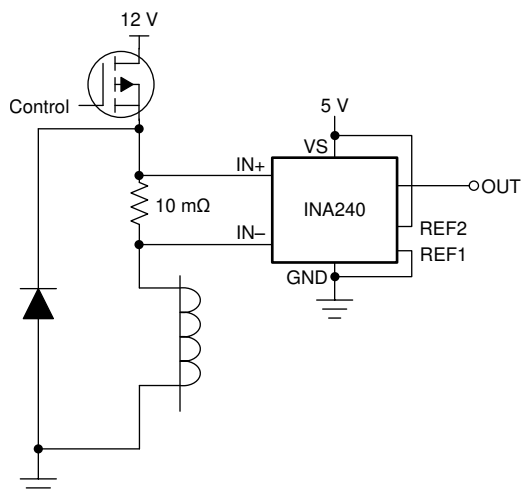
9.2.1.3 Application Curve



C005

图 9-4. Inline Motor Current-Sense Input and Output Signals

9.2.2 Solenoid Drive Current-Sense Application



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图 9-5. Solenoid Drive Application Circuit

9.2.2.1 Design Requirements

Challenges exist in solenoid drive current sensing that are similar to those in motor inline current sensing. In certain topologies, the current-sensing amplifier is exposed to the full-scale PWM voltage between ground and supply. The INA240 is well suited for this type of application.

9.2.2.2 Detailed Design Procedure

For this application, the INA240 measures current in the driver circuit of a 24-V, 500-mA water valve.

To demonstrate the performance of the device, the INA240A4 with a gain of 200 V/V was selected for this design and powered from a 5-V supply.

Using the information in the [Adjusting the Output Midpoint With the Reference Pins](#) section, the reference point is set to midscale by splitting the supply with REF1 connected to ground and REF2 connected to supply. Alternatively, the reference pins can be tied together and driven with an external precision reference.

A value of 10 mΩ was selected to maintain the analog input within the device limits.

9.2.2.3 Application Curve

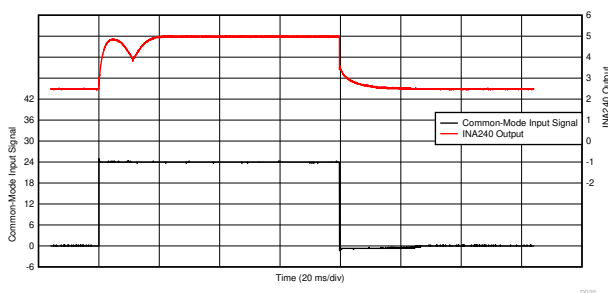


图 9-6. Solenoid Drive Current Sense Input and Output Signals

9.3 What to Do and What Not to Do

9.3.1 High-Precision Applications

For high-precision applications, verify accuracy and stability of the amplifier by:

- Providing a precision reference connected to REF1 and REF2
- Optimizing the layout of the power and sensing path of the sense resistor (see the [Layout](#) section)
- Providing adequate bypass capacitance on the supply pin (see the [Power Supply Decoupling](#) section)

9.3.2 Kelvin Connection from the Current-Sense Resistor

To provide accurate current measurements, verify the routing between the current-sense resistor and the amplifier uses a Kelvin connection. Use the information provided in [图 9-7](#) and the [Connection to the Current-Sense Resistor](#) section during device layout.

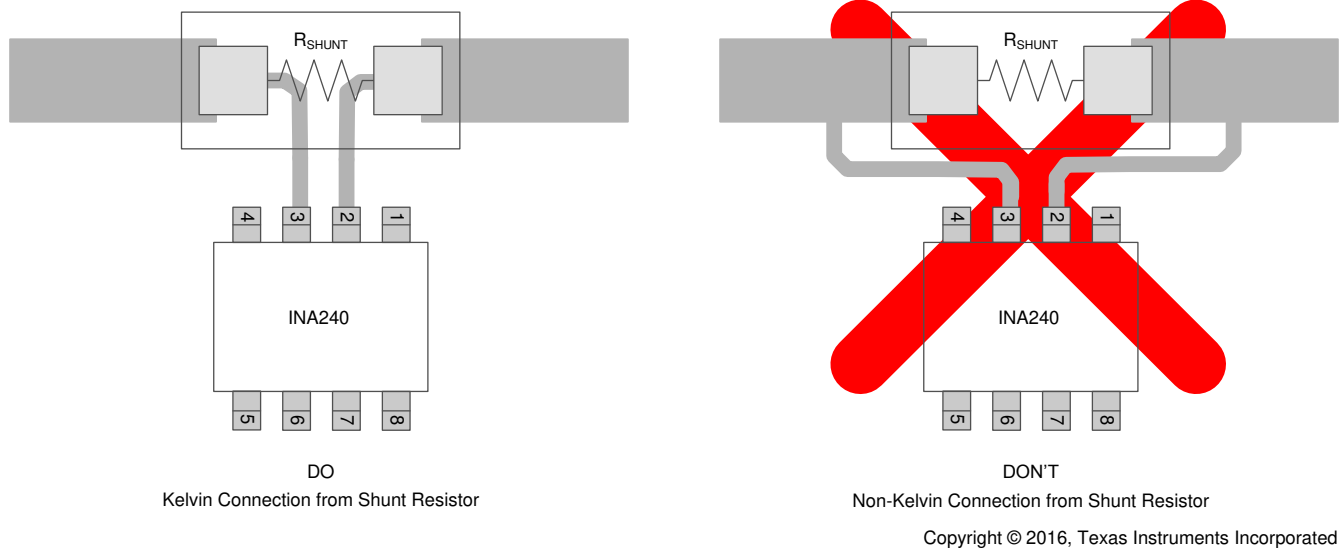


图 9-7. Shunt Connections to the INA240

10 Power Supply Recommendations

The INA240 series makes accurate measurements beyond the connected power-supply voltage (V_S) because the inputs (IN+ and IN-) operate anywhere between -4 V and 80 V independent of V_S . For example, the V_S power supply equals 5 V and the common-mode voltage of the measured shunt can be as high as 80 V.

Although the common-mode voltage of the input can be beyond the supply voltage, the output voltage range of the INA240 series is constrained to the supply voltage.

10.1 Power Supply Decoupling

Place the power-supply bypass capacitor as close as possible to the supply and ground pins. TI recommends a bypass capacitor value of 0.1 μ F. Additional decoupling capacitance can be added to compensate for noisy or high-impedance power supplies.

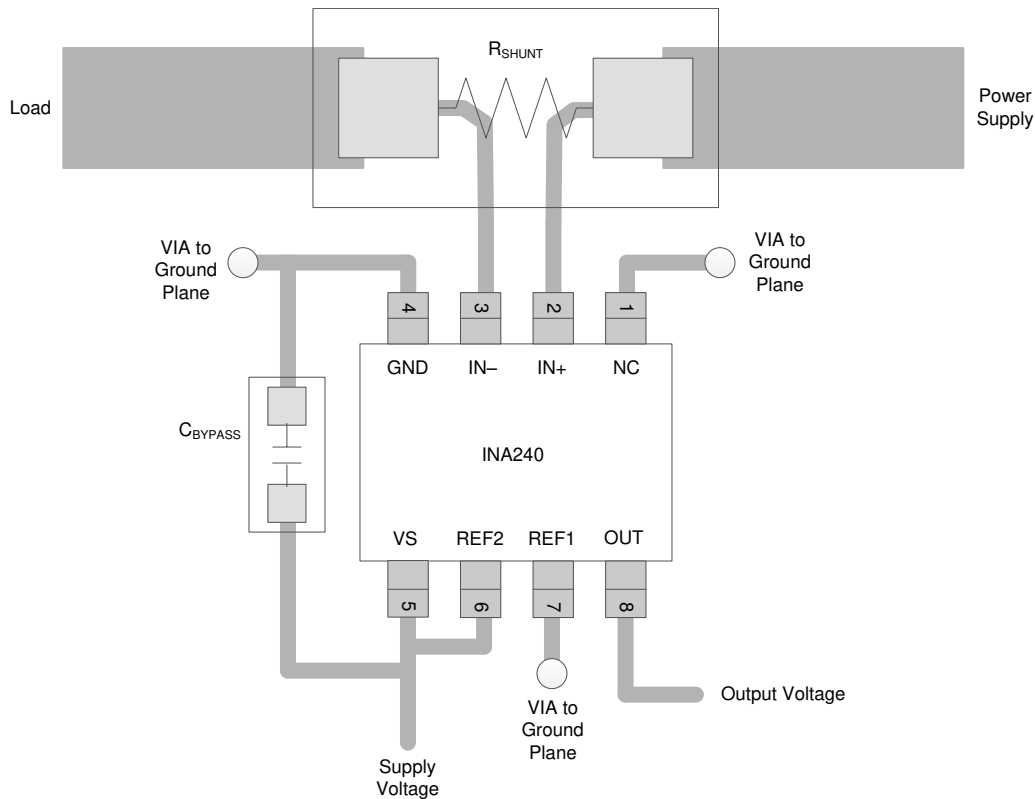
11 Layout

11.1 Layout Guidelines

11.1.1 Connection to the Current-Sense Resistor

Poor routing of the current-sensing resistor can result in additional resistance between the input pins of the amplifier. Any additional high-current carrying impedance can cause significant measurement errors because the current resistor has a very-low-ohmic value. Use a Kelvin or 4-wire connection to connect to the device input pins. This connection technique ensures that only the current-sensing resistor impedance is detected between the input pins.

11.2 Layout Example



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图 11-1. Recommended TSSOP Package Layout

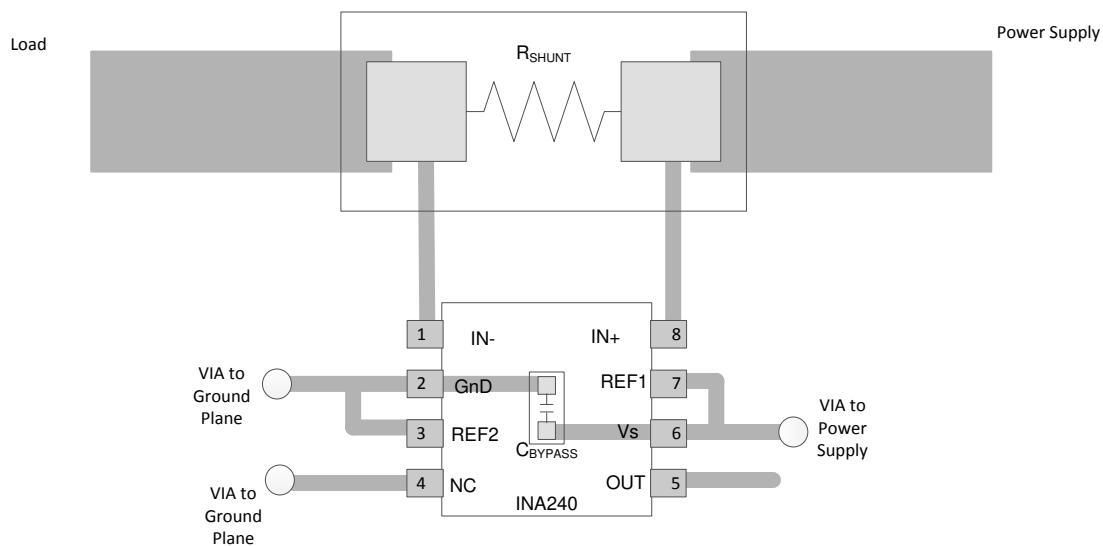


图 11-2. Recommended SOIC Package Layout

12 Device and Documentation Support

12.1 Documentation Support

12.1.1 Related Documentation

For related documentation see the following:

- Texas Instruments, [INA240EVM User's Guide](#)
- Texas Instruments, [Motor Control Application Report](#)
- Texas Instruments, [48-V Three-Phase Inverter With Shunt-Based In-Line Motor Phase Current Sensing Reference Design](#)

12.2 接收文档更新通知

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12.5 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

12.6 术语表

[TI 术语表](#) 本术语表列出并解释了术语、首字母缩略词和定义。

13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
INA240A1D	ACTIVE	SOIC	D	8	75	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	I240A1	Samples
INA240A1DR	ACTIVE	SOIC	D	8	2500	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	I240A1	Samples
INA240A1PW	ACTIVE	TSSOP	PW	8	150	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	I240A1	Samples
INA240A1PWR	ACTIVE	TSSOP	PW	8	2000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	I240A1	Samples
INA240A2D	ACTIVE	SOIC	D	8	75	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	I240A2	Samples
INA240A2DR	ACTIVE	SOIC	D	8	2500	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	I240A2	Samples
INA240A2PW	ACTIVE	TSSOP	PW	8	150	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	I240A2	Samples
INA240A2PWR	ACTIVE	TSSOP	PW	8	2000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	I240A2	Samples
INA240A3D	ACTIVE	SOIC	D	8	75	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	I240A3	Samples
INA240A3DR	ACTIVE	SOIC	D	8	2500	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	I240A3	Samples
INA240A3PW	ACTIVE	TSSOP	PW	8	150	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	I240A3	Samples
INA240A3PWR	ACTIVE	TSSOP	PW	8	2000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	I240A3	Samples
INA240A4D	ACTIVE	SOIC	D	8	75	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	I240A4	Samples
INA240A4DR	ACTIVE	SOIC	D	8	2500	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	I240A4	Samples
INA240A4PW	ACTIVE	TSSOP	PW	8	150	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	I240A4	Samples
INA240A4PWR	ACTIVE	TSSOP	PW	8	2000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	I240A4	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of ≤ 1000 ppm threshold. Antimony trioxide based flame retardants must also meet the ≤ 1000 ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF INA240 :

- Automotive : [INA240-Q1](#)

NOTE: Qualified Version Definitions:

- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

TAPE AND REEL INFORMATION


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
INA240A1DR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
INA240A1PWR	TSSOP	PW	8	2000	330.0	12.4	7.0	3.6	1.6	8.0	12.0	Q1
INA240A2DR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
INA240A2PWR	TSSOP	PW	8	2000	330.0	12.4	7.0	3.6	1.6	8.0	12.0	Q1
INA240A3DR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
INA240A3PWR	TSSOP	PW	8	2000	330.0	12.4	7.0	3.6	1.6	8.0	12.0	Q1
INA240A4DR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
INA240A4PWR	TSSOP	PW	8	2000	330.0	12.4	7.0	3.6	1.6	8.0	12.0	Q1

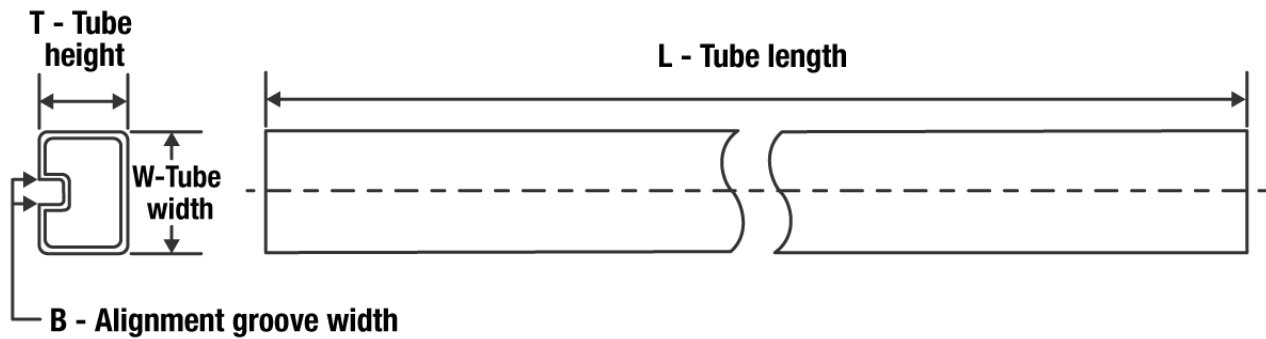
TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
INA240A1DR	SOIC	D	8	2500	340.5	336.1	25.0
INA240A1PWR	TSSOP	PW	8	2000	367.0	367.0	35.0
INA240A2DR	SOIC	D	8	2500	340.5	336.1	25.0
INA240A2PWR	TSSOP	PW	8	2000	367.0	367.0	35.0
INA240A3DR	SOIC	D	8	2500	340.5	336.1	25.0
INA240A3PWR	TSSOP	PW	8	2000	853.0	449.0	35.0
INA240A4DR	SOIC	D	8	2500	340.5	336.1	25.0
INA240A4PWR	TSSOP	PW	8	2000	853.0	449.0	35.0

TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
INA240A1D	D	SOIC	8	75	507	8	3940	4.32
INA240A1PW	PW	TSSOP	8	150	530	10.2	3600	3.5
INA240A2D	D	SOIC	8	75	507	8	3940	4.32
INA240A2PW	PW	TSSOP	8	150	530	10.2	3600	3.5
INA240A3D	D	SOIC	8	75	507	8	3940	4.32
INA240A3PW	PW	TSSOP	8	150	530	10.2	3600	3.5
INA240A4D	D	SOIC	8	75	507	8	3940	4.32
INA240A4PW	PW	TSSOP	8	150	530	10.2	3600	3.5



PACKAGE OUTLINE

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
4. This dimension does not include interlead flash.
5. Reference JEDEC registration MS-012, variation AA.

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:8X



SOLDER MASK DETAILS

4214825/C 02/2019

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE
BASED ON .005 INCH [0.125 MM] THICK STENCIL
SCALE:8X

4214825/C 02/2019

NOTES: (continued)

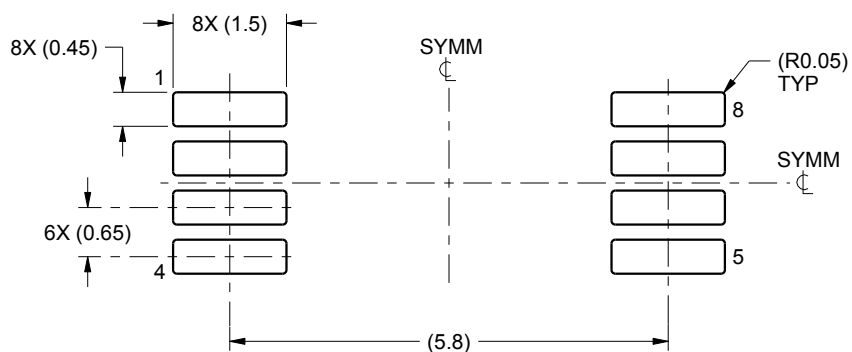
8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

EXAMPLE BOARD LAYOUT

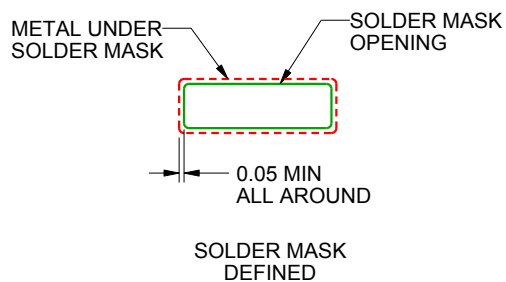
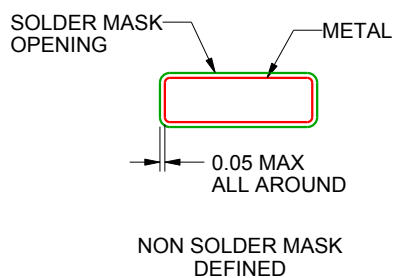
PW0008A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE
SCALE:10X



SOLDER MASK DETAILS
NOT TO SCALE

4221848/A 02/2015

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

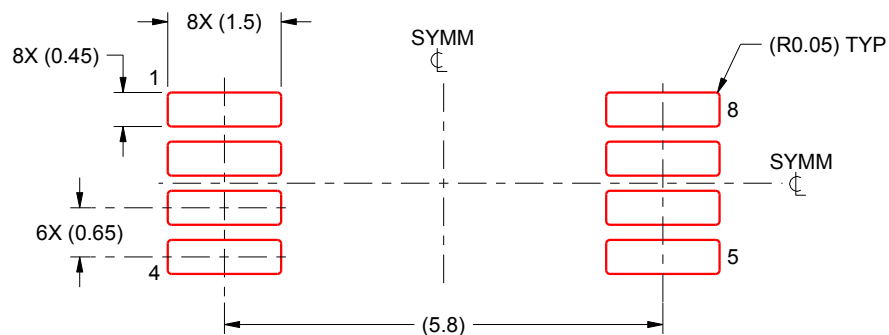
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

PW0008A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:10X

4221848/A 02/2015

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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